

For use with TO -220/TO -218/TO -247 packages

Part Number - SW63 -2G RoHS √ Compliant



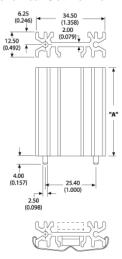
Products **Browse Products** -By Device --By Product Line---Attachment Methods -Interface Materials --Accessories -

Useful Links

- Building a Part #
 Catalog Request
- Directions
 Find Distributor
 Find Sales Rep
- How to Order?
 MSDS Safety Sheets
- Part # Cross Ref
 Quote Request
 RoHS Initiative

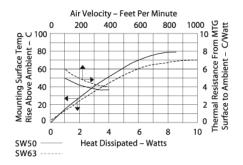
- Sample Request

Mechanical Outline Drawing



A Dim 63.00

Thermal Curves



Thermal Resistance	7.00
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Thermal resistance value is based on a 75°C rise in natural convection

Product Information

Part #	Description	Finish	Board Mounting
SW63 - 2G	Extruded heat sink with unequal channel widths front and back	Black Anodize	N/A

This non -electronic component is functionally unaffected by the normal soldering or reflow processes used for semiconductor circuits. The heat resistance time or heat resistance temperature is not applicable for the component.

Not Exactly what you need?

We offer several options for those applications which require a more unique solution. For slight modifications of this part or other attachment options, finishes, and interface materials, contact your local representative . Challenge us with your thermal requirements - we can design custom solutions.